Ultra-precision MLA masters using DPI[™] on-axis diamond turning technology

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Market segments and master requirements

Market segments:

- MLA sensors for mobile applications
- Automotive MLA headlights/carpets
- Wafer level CCM optics
- ...

Application needs for masters:

- Tight specifications on shapes, rugosity, form accuracy, ...
- All lenses identical
- · Short delivery time
- Masters should be as perfect as possible







^B Uielandts Technology: DPI™ on-axis SPDT machining

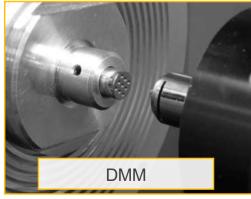
Dynamic Part Indexing (DPI[™]) is:

- Sequentially 2/3-axis turning of each lens of an array on the workspindle axis for best form and roughness
- Dynamically offset the part wrt the work-spindle in a balanced manner using eccentric rotary movements
- All lenses machined on same on axis position => identical !

But: could be all different (freeform) to compensate for replication repeatable errors.

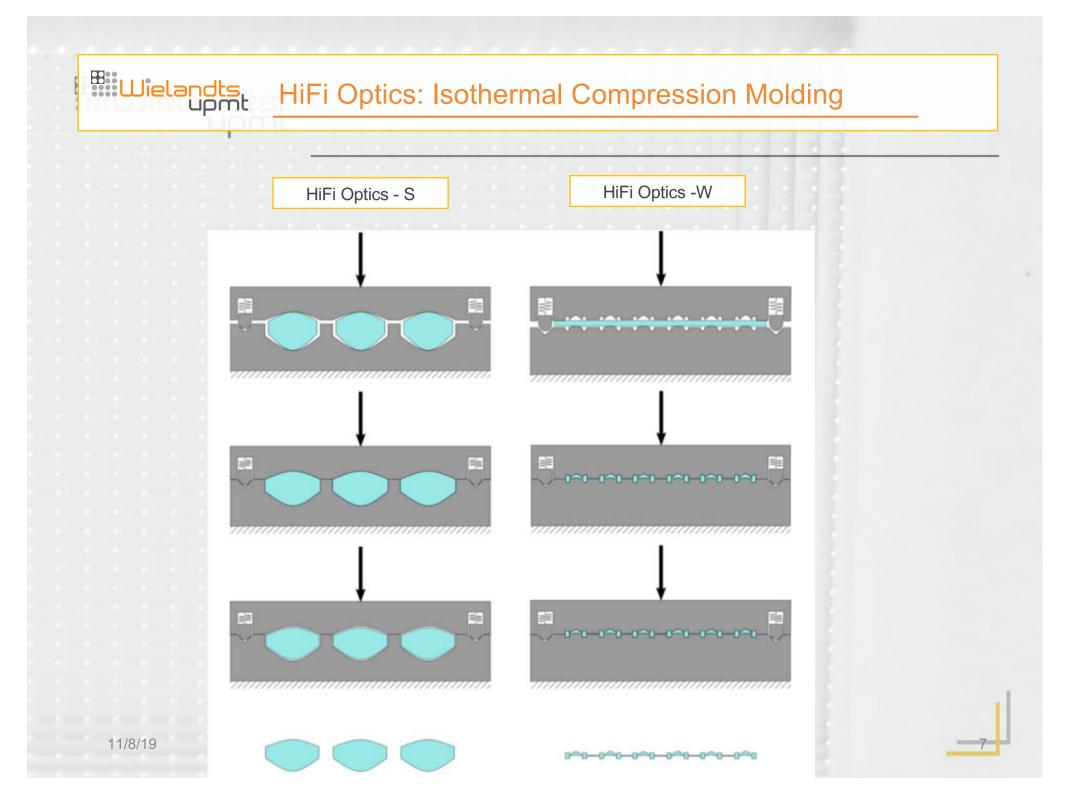






Comparison of MLA mastering technologies

Values from our knowledge before Phabulous project !	DPI™ On-axis Diamond Turning	Lithography	Laser Ablation
Form irregularity	100 nm p-v	300 nm p-v	> 1 µm p-v
Ra roughness	2 nm	20 - 40 nm	100 - 200 nm
Shapes	Aspheres/ freeforms with some degree of rotation symmetry (astigmats, saddle, golf ball)	Reflow: spheres Gray scale: freeforms	Freeforms
Optical feature sizes	> 30 μm (XY), sag (Ζ) > 5 μm	Sag (Ζ) < 60 μm – 100 μm	Sag (Ζ) < 200 μm
Edge slopes	< 75°	< 90°	90°
Diffractive structures	Yes (Fresnel)	Reflow: no Gray scale: yes multi-level	Yes
100% fill factor	Concave: yes Convex: by inverted copy	Reflow: no Gray scale: yes	Yes
Position accuarcy	1 - 2 µm	< 1 µm	1 µm

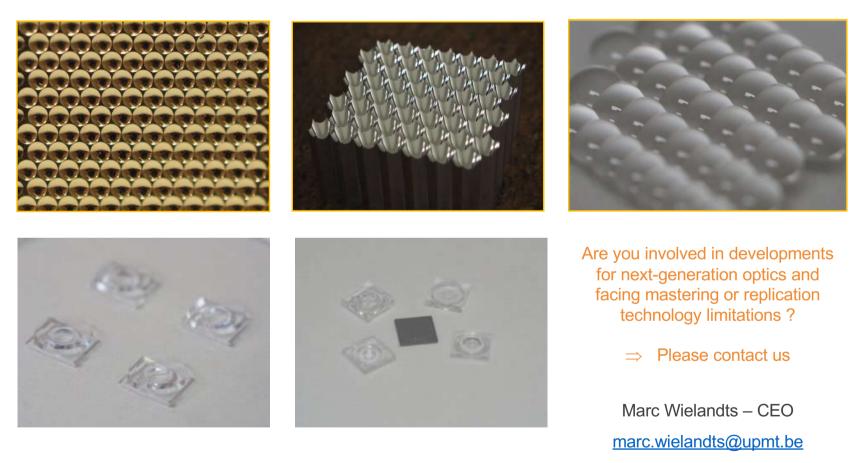


Challenges & Challenges

- Lens-to-lens positioning < 1 μm
- Long term deviation closed loop control
- Strong and high spatial frequency freeform lens arrays (Phabulous)
- HiFi Optics[™] isothermal compression molding
 - Convex MLA masters with 100% fill factor
 - Double sided thin, high-aspect ratio lens wafers
 - Materials and coatings
- Machining of monolithic hard material multi-cavity molds



Innovative Technologies for your Lens Array Manufacturing



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